

Serbian Contribution for High Performance and High Aided Value Manufacturing – An Industrial Application

Prof. Dr. Vidosav D. MAJSTOROVIĆ

*Faculty of Mechanical Engineering
University of Belgrade, Serbia*

1. INTRODUCTION

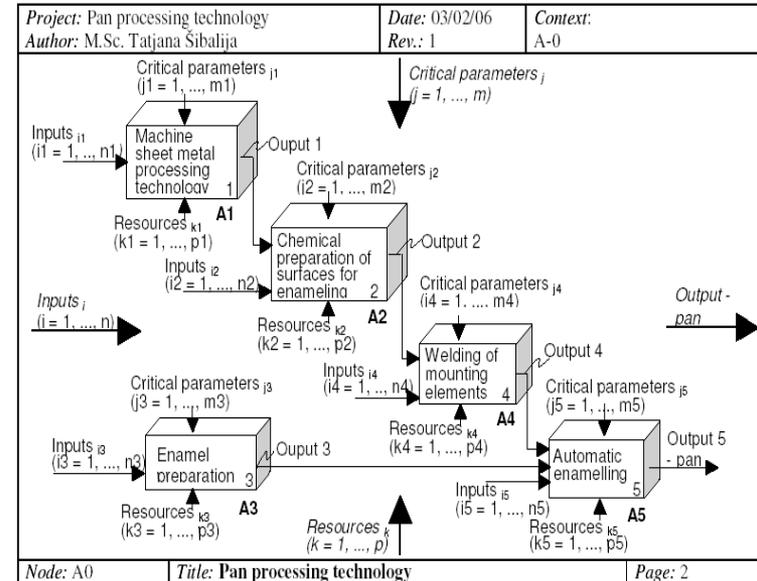
- The **implementation of the advanced quality improvement programs**, such as six sigma, could present a step in accomplishing top priorities of *Manufature SRA*, e.g. **zero-defect paradigm** and **knowledge-based manufacturing**, particularly in developing countries and also in Serbia – *Serbian Contribution for High Performance and High Aided Value Manufacturing - An Industrial Application*.
- **Six sigma**: disciplined approach to **improving product and process quality**, based on customer quality requirements.
 - **From ‘intuition-based decisions’** (what we think is wrong), **to ‘fact-based decisions’** (what we know is wrong)
 - For **the existing system**, six sigma is deployed according to **DMAIC** (Define-Measure-Analyse-Improve-Control) systematic procedure
- **A case study** performed in a Serbian cookware production system to **reduce the product (enamelled pot) defects** using six sigma – DMAIC approach:
 - **Define**: presented in brief (IDEF0, Pareto, Ishikawa, ...)
 - **Measure**: presented in brief (MSA, ...)
 - **Analysis**: **process performance analysis for non-normal data distribution**
 - **Improvement**: **Taguchi's location and dispersion modelling** approach for process parameters optimisation
 - **Control**: presented in brief

2. SIX SIGMA APPLICATION - *Define*

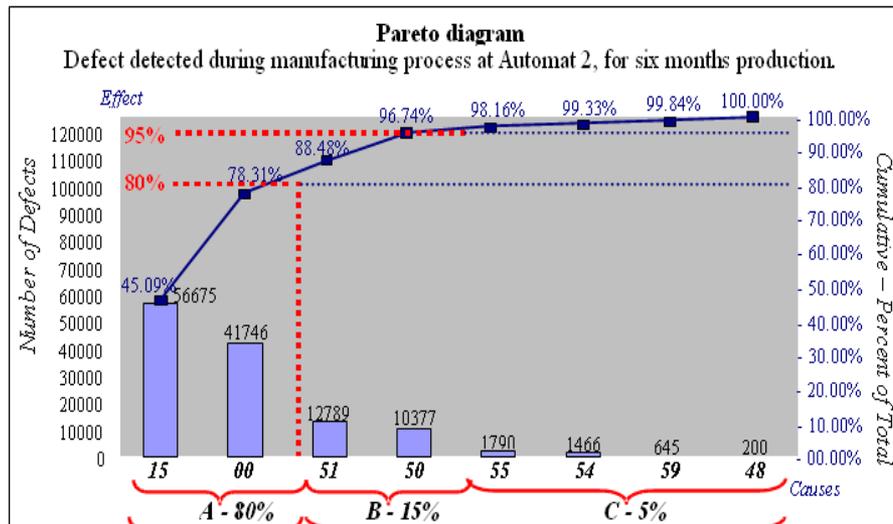
➤ **DMAIC approach** - reduce waste and cost of poor quality (COPQ) and improve sigma level of the **automatic enamelling process (cookware production system)**

Define:

1. Process mapping (**IDEF0** method): main processes, sub-processes and activities
2. **Pareto** analysis: rank defect found in the automatic enamelling process → **vital defects** mainly related to the **pot enamel thickness**
3. **Ishikawa** diagrams: analyse vital defects and their main causes → the majority of the defects are related to **sub-process base enamelling**



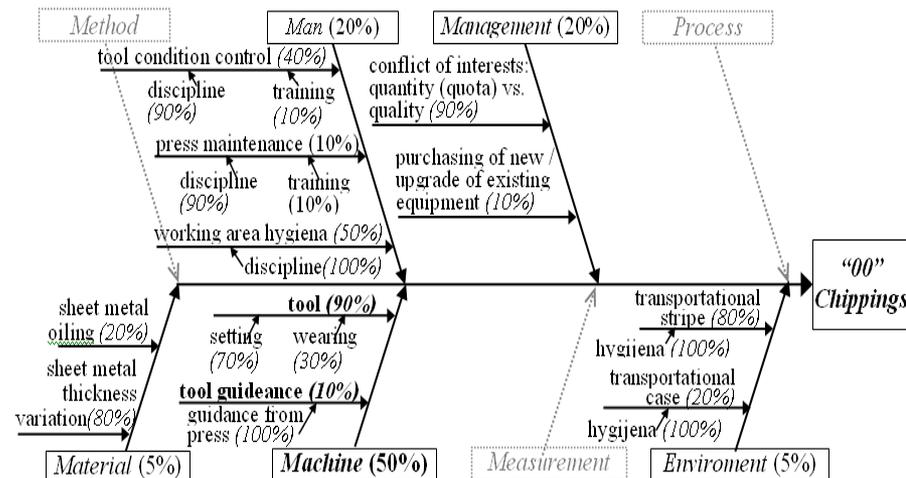
IDEF0: system decomposed presentation



Vital Factors / Defects
 "vital few" ~ 80%

Trivial Factors / Defects
 "useful / trivial many" ~ 20%

Pareto analysis



Ishikawa analysis

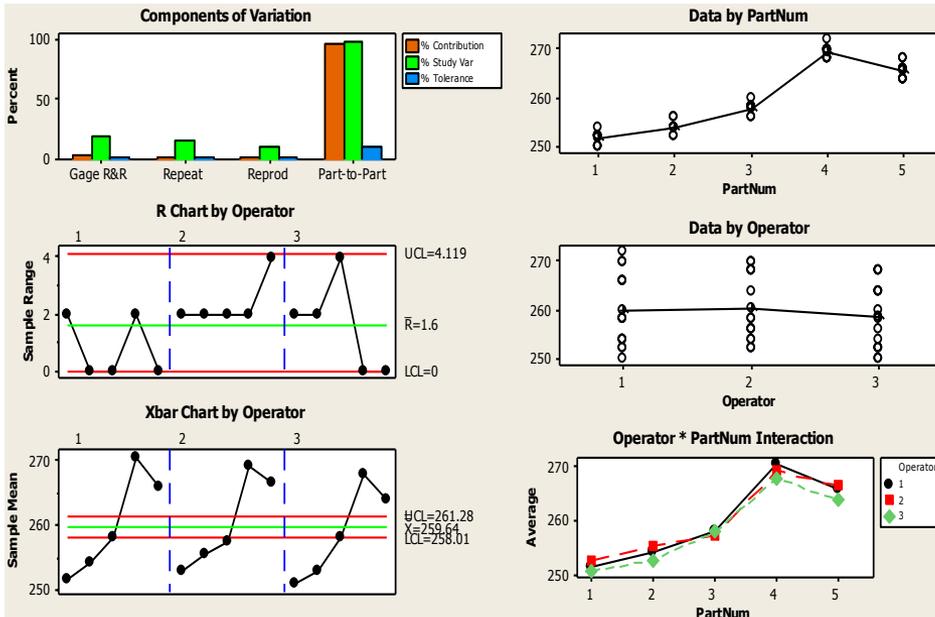
2. SIX SIGMA APPLICATION - *Measure*

Measure:

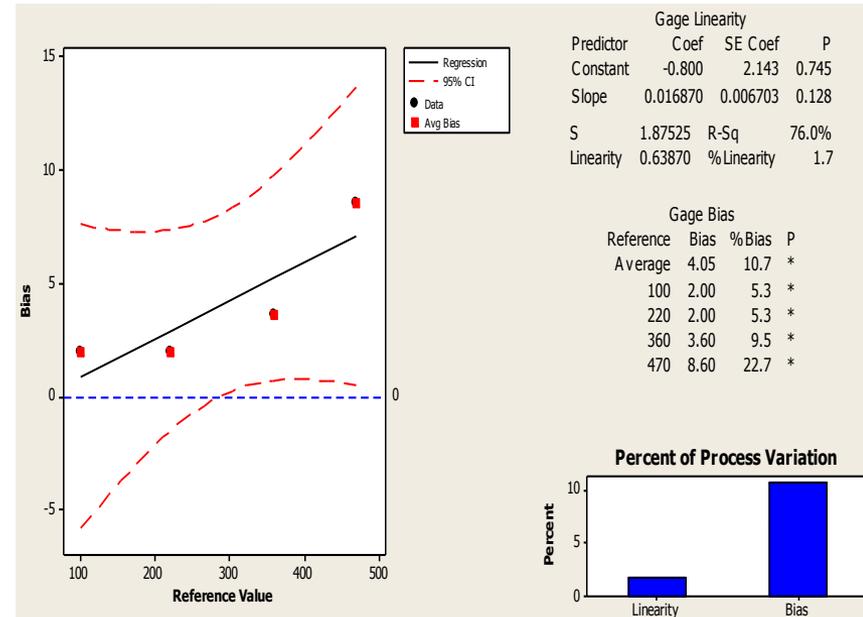
Measuring System Analysis (MSA) - to verify the measuring system used to measure the pot enamel thickness

- **Gage R&R** - to estimate the equipment variation (repeatability), operator variability (reproducibility) and variation of pot enamel thickness (part-to-part variation)
 - - operators and equipment caused < 20% of variation
 - number of distinct categories = 7 (> 5 - the minimal requirement) } - **OK**
- **Linearity and Bias Study** → the gage bias was statistically insignificant - **OK**

Conclusion: the measuring system could be accepted for the measurement of pot enamel thickness and process analysis



Gage R&R Study



Linearity and Bias Study



2.1. Process Performance Analysis

Analyse:

Process capability & performance analysis

- **Process capability indices** show what is achievable rather than what is currently being achieved :
 - **Cp** (ratio of the specification width to the natural tolerance spread of the process)
 - **Cpk** (specification width with respect to how well the process spread is located about the target) - incorporate the measure of process location

The assumptions required for the interpretation of the process capability indices:

- process stability;
- representative samples;
- normality (the underlying process distribution is normal);
- independences (the observations are independent of each other).

- **Process performance indices do not assume that the process is in-control or is normally distributed** and they use all of the data collected:
 - Pp
 - Ppk

The process performance indices use the **within sample standard deviation including both common and special cause of variation**, hence they **provide a more realistic assessment of what is being produced**.

2.1. Process Performance Analysis: Non-Normal Distribution ⁽¹⁾

Process performance for a non-normal distribution

- Clement's method based on Pearson family of distribution estimates capability indices based on evaluation of the skewness and kurtosis - by replacing the unknown 6σ distance by $Up - Lp$ based on the available sample data, a **natural tolerance** is:

$$Tolerance_{natural} = Up - Lp = X_{0.99865} - X_{0.00135} \quad (1)$$

- Process performance calculation does not require the assumption that the underlying process distribution is normal - **the process performance indices for non-normal distribution** could be expressed as:

$$Pp = \frac{USL - LSL}{X_{0.99865} - X_{0.00135}} \quad Ppk = \min \left\{ \frac{USL - X_{0.50}}{X_{0.99865} - X_{0.50}}; \frac{X_{0.50} - LSL}{X_{0.50} - X_{0.00135}} \right\} \quad (2)$$

where:

- Up and Lp estimate the 99.865 and the 0.135 percentile, and the distance between 99.865th and 0.135th percentiles is equivalent to the 6σ spread in the normal case
- the process median is presented by the 50th percentile value for the non-normal distribution, which is equivalent to the average value in case of normal distribution

2.1. Process Performance Analysis: Non-Normal Distribution ⁽²⁾

➤ Automatic base enamelling:

- specification limits for base enamel thickness $LSL \div USL = 80 \div 120 \mu m$
- the specified target value = $95 \mu m$

• **process does not follow the normal distribution** - the **Weibull distribution** is the best one to fit the actual process data (confirmed by Anderson-Darling goodness-of-fit and p -value tests)

- **$P_p = 1.26$** → the process is capable of producing min. 99.74 % of conforming parts
- **$P_{pk} = 1.10$** → lower than the value required for 'six sigma process'
- the process median is off the target → **the location problem**

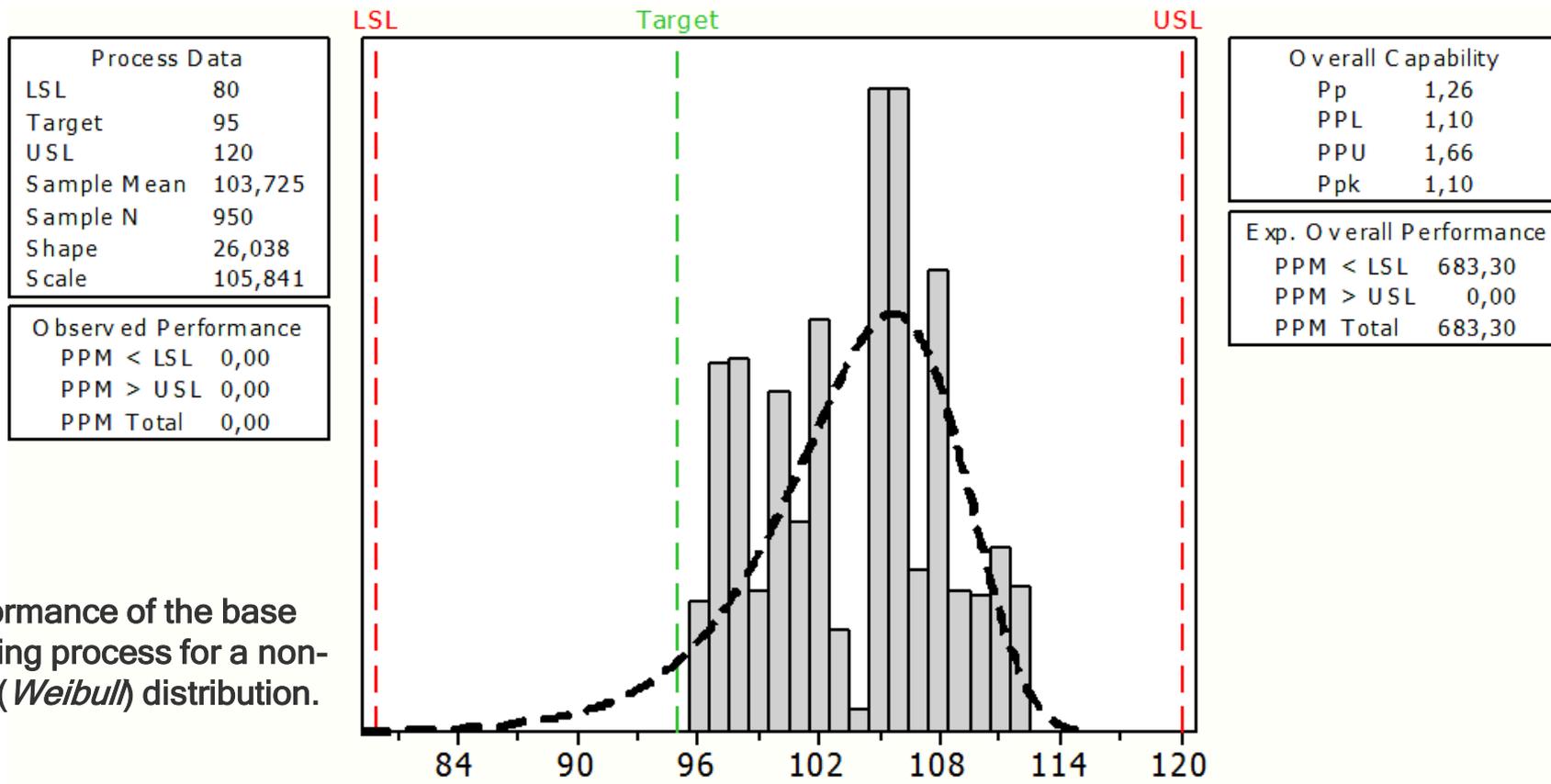


Fig. 1. Performance of the base enamelling process for a non-normal (*Weibull*) distribution.

2.2. Process Parameters Optimisation

Improve:

Location and Dispersion Modelling

- Improve process capability using **Taguchi's location and dispersion modelling**:
 - **identification of the control parameter & interaction effects on location (mean) and dispersion (variation)** of the observed quality characteristic (response)

At each control factors setting, the sample **mean** y_i and sample **variance** σ_i are used to present the location and dispersion:

$$\gamma_i = \frac{1}{n_i} \sum_j y_{ij} \quad \sigma_i^2 = \frac{1}{n_i - 1} \sum_j (y_{ij} - \bar{y}_i)^2 \quad (3)$$

where n_i is number of replicates at for the i th control factors setting.

- The **half-normal probability plot** is a graphical tool that uses ordered estimated effects to help assess which factors are important - least squares estimation – a list of the main effects and interactions ordered by the effect magnitude:
 - **unimportant factors** are those that have **near-zero effects** - centred near zero
 - **important effects** tend to have a distribution centred at their respective true large (but unknown) effect values

2.2. Process Parameters Optimisation: experiment

- Process performance analysis: the automatic base enamelling process needs optimisation to **solve the location problem** (achieve the target base enamelling thickness) and **improve process performance** (Pp and Ppk values)

- **Experiment** – to identify the optimal settings of critical-to-quality (CTQ) control parameters and interactions for the process - process parameters (control factors):
 - **enamel parameters:**
 - specific weight (**SW**) [gram cm⁻³]: lower ('-1') / upper ('+1') level = 8.0 / 11.0 [gram cm⁻³]
 - deposit weight (**DW**) [gram cm⁻³]: lower ('-1') / upper ('+1') level = 1.68 / 1.70 [gram cm⁻³]
 - **SW · DW** interaction
 - **process parameters:**
 - pouring speed (**PS**) [turns min⁻¹]: lower ('-1') / upper ('+1') level = 0.0 / 3.0 [turns min⁻¹]
 - automat speed (**AS**) [parts min⁻¹]: lower ('-1') / upper ("+1") level = 5.0 / 9.0 [turns min⁻¹]
 - **PS · AS** interaction

- ✓ Design of the experiment - Taguchi orthogonal array **L16** (16 experim. trials)

- ✓ **Half-normal plots:** to model the relationship between the response (base enamelling thickness) location/dispersion and control factors - to **show the significance of parameters and interactions effects on the response**

2.2. Process Parameters Optimisation: location modelling

- Location half-normal plot (Fig. 2.a.): significant effects on location (MEAN) are effects of **SW, DW, PS** and **AS·SW·DW** – **location regression equitation:**

$$MEAN = 87.8 + 6.51 \cdot SW + 5.74 \cdot DW + 3.02 \cdot SW \cdot DW \cdot AS + 2.79 \cdot PS \quad (4)$$

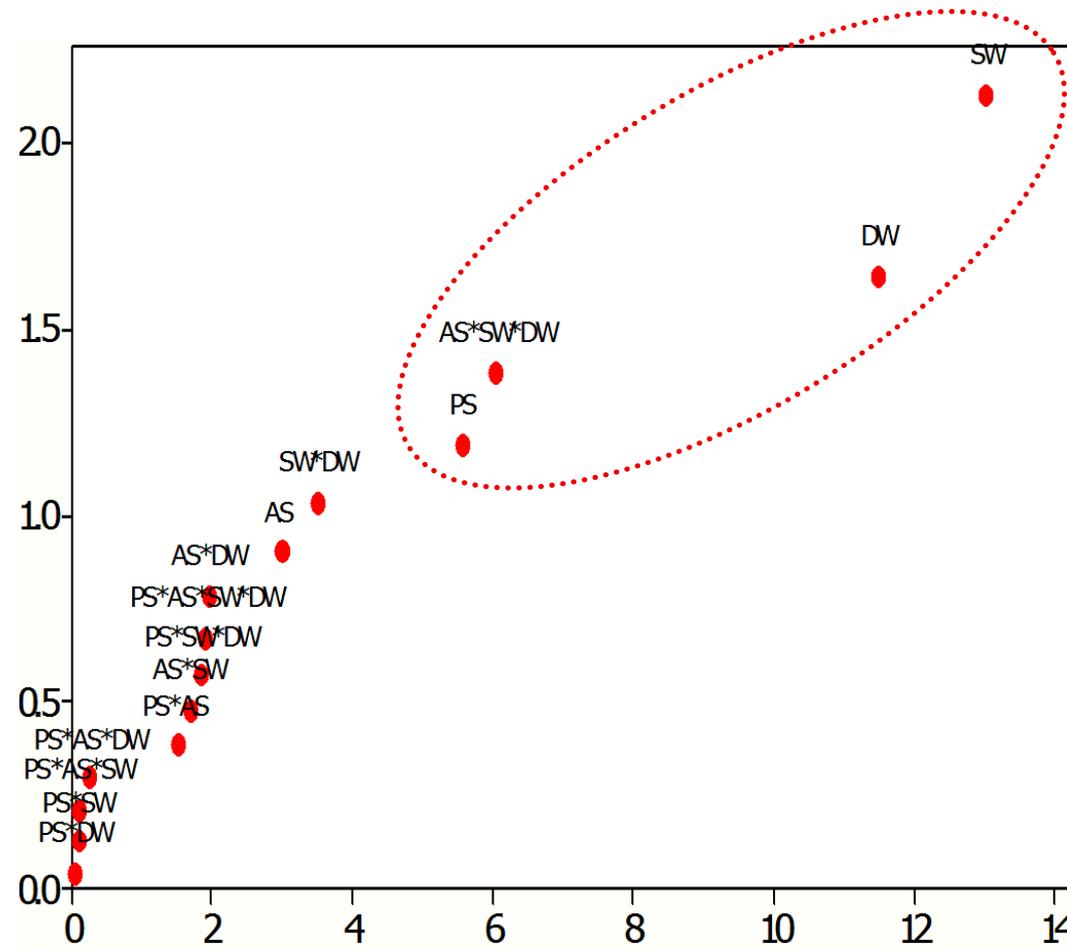
according to the results of regression analysis presented in table 1.a.

Table 1.a. Statistical parameters of regression equitation for location modelling

Location modelling			
Predictor	Coef.	T	P
Constant	87.80	95.79	0.000
SW	6.51	7.10	0.000
DW	5.74	6.26	0.000
SW·DW·AS	3.02	3.30	0.007
PS	2.79	3.04	0.011

< 0.05

Fig. 2.a.
Half-normal plot of location
(response mean value) effects



2.2. Process Parameters Optimisation: dispersion modelling

- Dispersion half-normal plot (Fig. 2.b.): significant effects on location (Ln Sigma^2) are effects of **PS, PS·AS, DW** and **PS·DW** – **dispersion regression equitation**:

$$\text{LnSigma}^2 = 3.22 + 0.25 \cdot \text{PS} + 0.2 \cdot \text{PS} \cdot \text{AS} + 0.19 \cdot \text{DW} + 1.6 \cdot \text{DW} \cdot \text{PS} \quad (5)$$

according to the results of regression analysis presented in the table 1.b.

Table 1.b. Statistical parameters of regression equitation for dispersion modelling

Dispersion modelling			
Predictor	Coef.	T	P
Constant	3.22	55.33	0.000
PS	0.25	4.33	0.001
PS·AS	0.20	3.51	0.005
DW	0.19	3.20	0.008
DW·PS	0.16	2.76	0.018

< 0.05

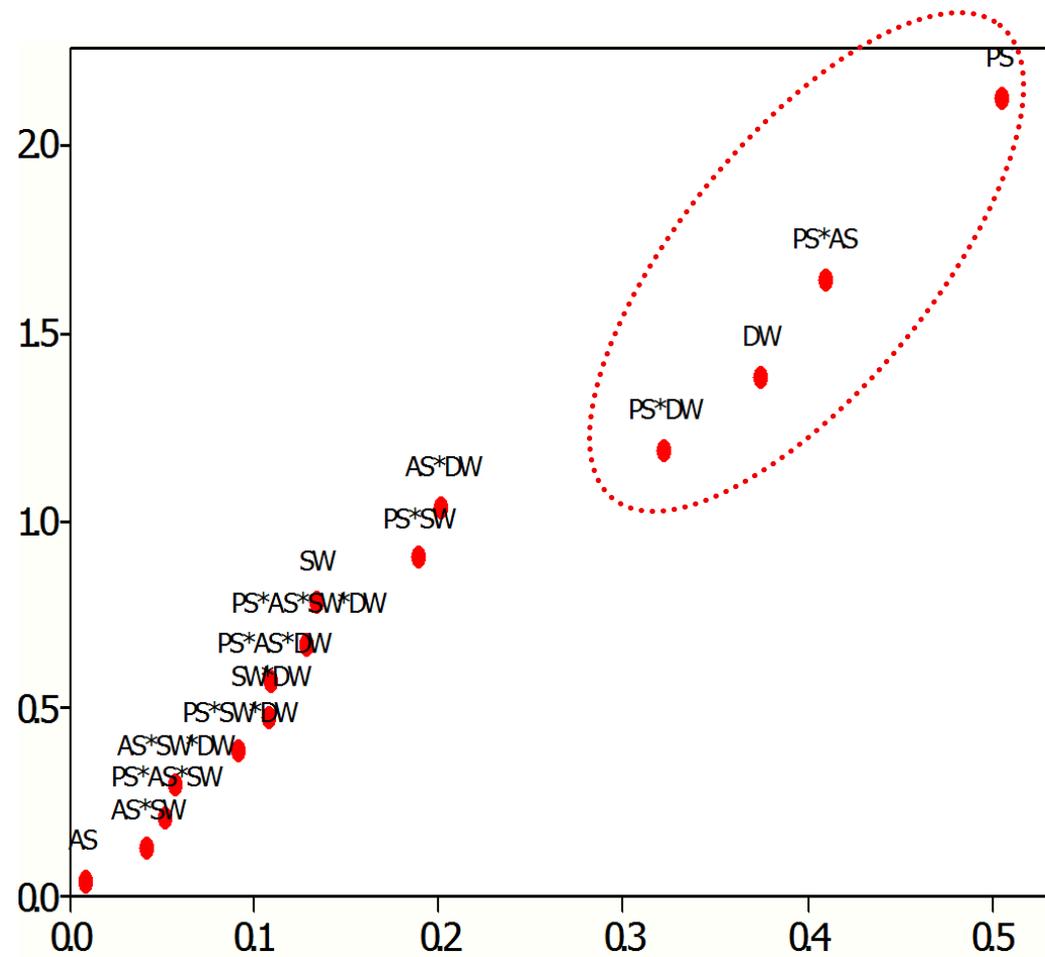


Fig. 2.b.
Half-normal plot of dispersion
(Ln Sigma^2) effects

2.2. Process Parameters Optimisation: optimal solution

- ✓ **The objective:** achieve the nominal (**target**) response mean value of **95 μm**
- According to the **two-step procedure for Nominal-The-Best (NTB) problem:**

1. Select the levels of dispersion factors to **minimise dispersion:**

From the regression equation for dispersion effects:

$$\text{LnSigma}^2 = 3.22 + 0.25 \cdot PS + 0.2 \cdot PS \cdot AS + 0.19 \cdot DW + 1.6 \cdot DW \cdot PS \quad (5)$$

- recommended levels of dispersion factors: **PS at “-1” (0.0), AS at “+1”(9.0)**
- factor SW could be used to bring the mean on the target depends of the DW level

2. Select the levels of location factors to **bring mean to the target:**

From regression equation for location effects:

$$\text{MEAN} = 87.8 + 6.51 \cdot SW + 5.74 \cdot DW + 3.02 \cdot SW \cdot DW \cdot AS + 2.79 \cdot PS \quad (4)$$

and by solving the following equation (6):

$$95 = 87.8 + 6.51 \cdot SW + 5.74 \cdot DW + 3.02 \cdot SW \cdot DW \cdot (+1) + 2.79 \cdot (-1) \quad (6)$$

there are two possible solutions:

- (a.) **DW at “-1” (1.68)** then calculated **SW = 16.2** – not practically possible
- (b.) **DW at “+1” (1.70)** then calculated **SW = 10.5 ≈ 11.0** - OK

➤ **Optimal parameters setting: DW=1.70; SW=11.0; PS=0.0; AS=9.0**

2.3. Discussion

- *Previously* - automatic enamelling process capability study performed under the **assumption of normal distribution** - **results misleading** (e.g. $P_p > C_p$ and $C_p > C_{pk}$, which is practically impossible).
This highlights **the importance of a proper calculation of process performance** indices, providing accurate data for the customer and for the process improvement.
- *Previously* - the analysis of the enamelling process experiment was performed using **ANOVA**. Although both methods resulted in the same optimal parameters setting, **the location and dispersion modelling outperformed ANOVA** – it found **new significant interactions** - effects on mean (AS·SW·DW) and variation (PS·DW) that ANOVA did not detect.

Control:

- Verification run confirmed the results of experimental analysis:
enamel thickness **mean = 96 μm** , *enamel thickness* **st. deviation = 4.5 μm**
presenting **significant improvement** in comparison to the previous performance.
- Taguchi's quality loss function:
 - loss caused by previous performance **$L_p(Y) = K \cdot 70.06$** units (mean was 103.37 μm)
 - loss after optimisation is **$L_o(Y) = K \cdot 2.99$** units
 - ... expected that after optimisation the **loss will be reduced ≈ 23 times** -
defects will be significantly reduced and process performance improved!

3. CONCLUDING REMARKS

- **Process performance analysis**: the significance of the **accurate estimation of process performance indices for non-normal distribution**.
- **Location and dispersion modelling**: clarified **a total contribution of control factors and interactions to the variation in the process** – successful method to optimise the observed single-response system.
- ✓ **Six Sigma** project implementation:
 - the first step in introducing **advanced quality improvement programs in Serbia as a Serbian *Manufuture* Program**
 - the success of project **depends on a management devotion** and it **requires cultural changes** (i.e. ‘facts-based’ decision making instead of ‘experience or intuition-based’).
 - importance of a theoretical underpinning and a proper training of company's personnel - to **bridge the gap between the theory and practice of six sigma**

Thank you for your attention!

Questions / Comments?!

Prof. Dr. Vidosav MAJSTOROVIĆ

vidosav.majstorovic@sbb.rs

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